

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|---------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CBO} | 60 | V |
| Collector-Emitter Voltage | V _{CEO} | 40 | V |
| Emitter-Base Voltage | V _{EBO} | 6.0 | V |
| Collector Current | I _C | 600 | mA |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 6) | P _D | 200 | mW |
| Thermal Resistance, Junction to Ambient (Note 6) | R _{θJA} | 625 | °C/W |
| Operating and Storage and Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

ESD Ratings (Note 7)

| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V | 3A |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | C |

- Notes:
6. For the device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

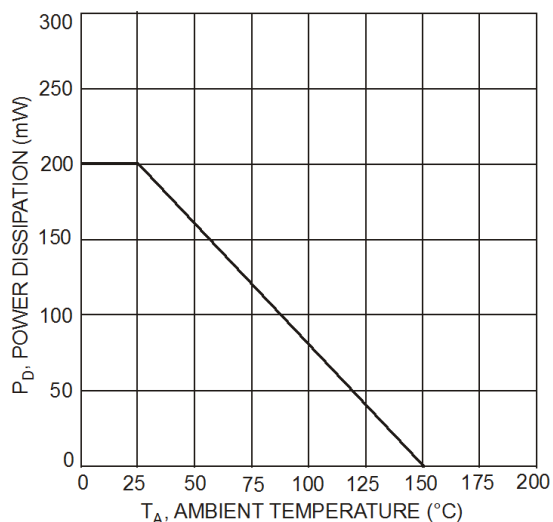
Thermal Characteristic and Derating Information


Fig. 1 Max Power Dissipation vs. Ambient Temperature

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Max | Unit | Test Condition |
|--|----------------------|-----------|--------------|--------------------|---|
| OFF CHARACTERISTICS | | | | | |
| Collector-Base Breakdown Voltage | BV _{CBO} | 60 | — | V | I _C = 100μA, I _E = 0 |
| Collector-Emitter Breakdown Voltage (Note 8) | BV _{CEO} | 40 | — | V | I _C = 10.0mA, I _B = 0 |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 6.0 | — | V | I _E = 100μA, I _C = 0 |
| Collector-Emitter Cut-Off Current | I _{CEX} | — | 100 | nA | V _{CE} = 35V, V _{EB(OFF)} = 0.4V |
| Base Cut-Off Current | I _{BL} | — | 100 | nA | V _{CE} = 35V, V _{EB(OFF)} = 0.4V |
| ON CHARACTERISTICS (Note 8) | | | | | |
| DC Current Gain | h _{FE} | 20 | — | — | I _C = 100μA, V _{CE} = 1.0V |
| | | 40 | — | | I _C = 1.0mA, V _{CE} = 1.0V |
| | | 80 | — | | I _C = 10mA, V _{CE} = 1.0V |
| | | 100 | 300 | | I _C = 150mA, V _{CE} = 1.0V |
| | | 40 | — | | I _C = 500mA, V _{CE} = 2.0V |
| Collector-Emitter Saturation Voltage | V _{CE(SAT)} | — | 0.40 0.75 | V | I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA |
| Base-Emitter Saturation Voltage | V _{BE(SAT)} | 0.75 — | 0.95 1.2 | V | I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA |
| SMALL SIGNAL CHARACTERISTICS | | | | | |
| Output Capacitance | C _{obo} | — | 6.5 | pF | V _{CB} = 5.0V, f = 1.0MHz, I _E = 0 |
| Input Capacitance | C _{ibo} | — | 30 | pF | V _{EB} = 0.5V, f = 1.0MHz, I _C = 0 |
| Input Impedance | h _{ie} | 1.0 | 15 | kΩ | V _{CE} = 10V, I _C = 1.0mA, f = 1.0kHz |
| Voltage Feedback Ratio | h _{re} | 0.1 | 8.0 | x 10 ⁻⁴ | |
| Small Signal Current Gain | h _{fe} | 40 | 500 | — | |
| Output Admittance | h _{oe} | 1.0 | 30 | μs | |
| Current Gain-Bandwidth Product | f _T | 250 | — | MHz | V _{CE} = 30V, I _C = 150mA, f = 100MHz |
| SWITCHING CHARACTERISTICS | | | | | |
| Delay Time | t _D | — | 15 | ns | V _{CC} = 30V, I _C = 150mA, V _{BE(OFF)} = 2.0V, I _{B1} = 15mA |
| Rise Time | t _R | — | 20 | ns | |
| Storage Time | t _S | — | 225 | ns | V _{CC} = 30V, I _C = 150mA, I _{B1} = - I _{B2} = 15mA |
| Fall Time | t _F | — | 30 | ns | |

Note: 8. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

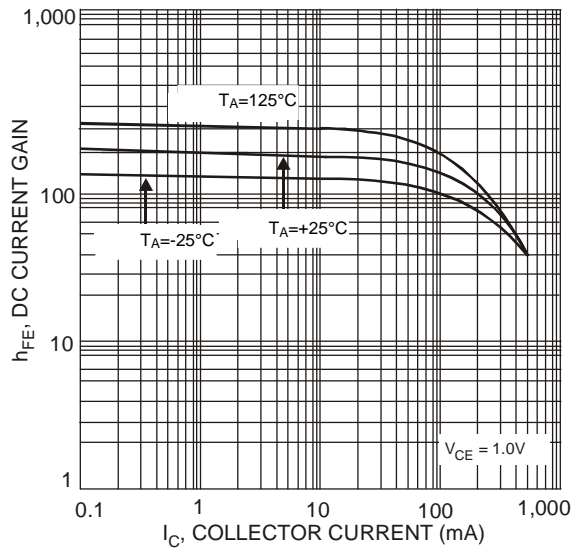


Fig. 2 Typical DC Current Gain vs. Collector Current

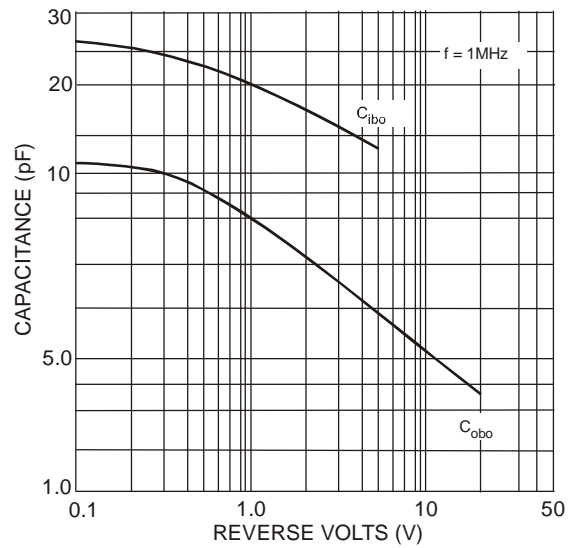


Fig. 3 Typical Capacitance

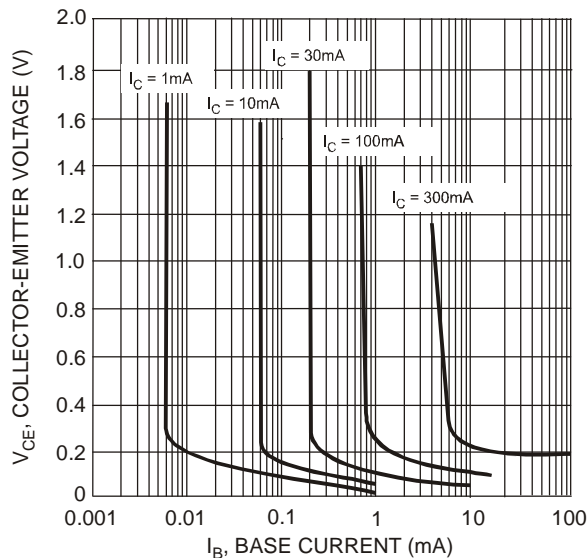


Fig. 4 Typical Collector Saturation Region

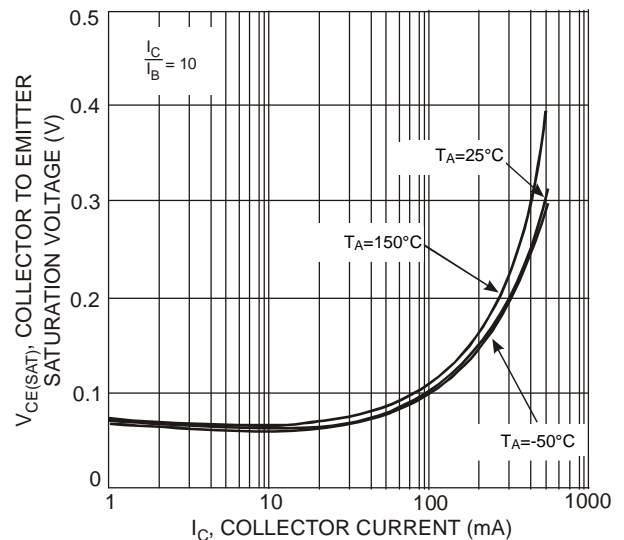


Fig. 5 Collector Emitter Saturation Voltage vs. Collector Current

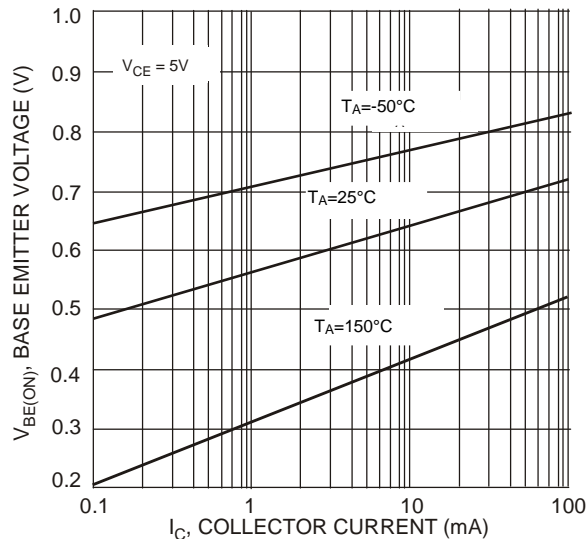


Fig. 6 Base Emitter Voltage vs. Collector Current

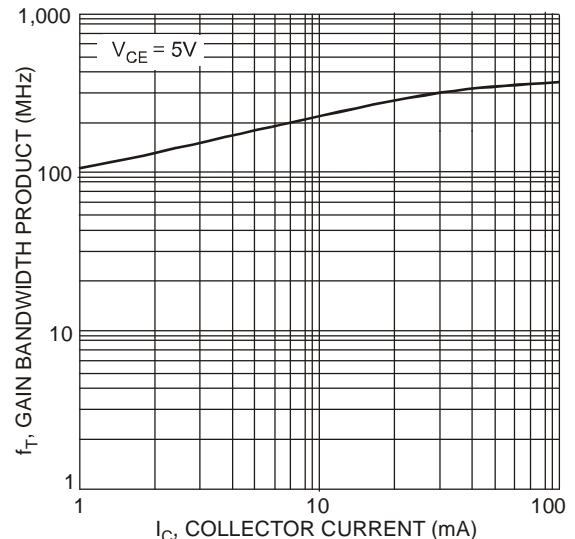
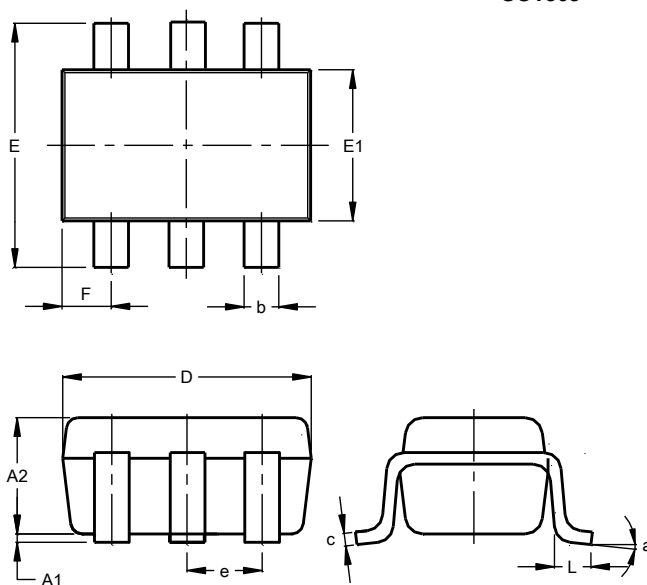


Fig. 7 Gain Bandwidth Product vs. Collector Current

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363

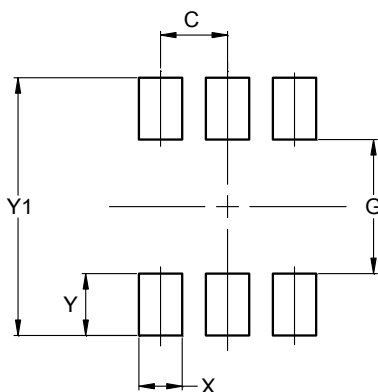


| SOT363 | | | |
|----------------------|-----------|------|-------|
| Dim | Min | Max | Typ |
| A1 | 0.00 | 0.10 | 0.05 |
| A2 | 0.90 | 1.00 | 1.00 |
| b | 0.10 | 0.30 | 0.25 |
| c | 0.10 | 0.22 | 0.11 |
| D | 1.80 | 2.20 | 2.15 |
| E | 2.00 | 2.20 | 2.10 |
| E1 | 1.15 | 1.35 | 1.30 |
| e | 0.650 BSC | | |
| F | 0.40 | 0.45 | 0.425 |
| L | 0.25 | 0.40 | 0.30 |
| a | 0° | 8° | -- |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.650 |
| G | 1.300 |
| X | 0.420 |
| Y | 0.600 |
| Y1 | 2.500 |

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